

Amendments to the Specification are as follows:

Before the first sentence on page 1 please insert the following paragraph.

This application claims the benefit of priority to Japanese Patent Application Nos. 2003-069330 and 2003-293390, herein incorporated by reference.

Please amend the paragraph beginning on page 5, line 4 and ending on page 5, line 10 as follows:

Embodiments of the present invention~~The present invention has been made for solving the problems described above, and it is an object thereof to provide a thin film magnetic head capable of further simply connecting between first coil pieces and second coil pieces with small connection resistance as well as being capable of improving the magnetization efficiency while suppressing the magnetic saturation.~~